



- NOTES:
- MATERIAL:
HOUSING: LCP, BLACK, UL 94V-0
CONTACT: PHOSPHORBRONZE, T=0.10MM
SHELL: STAINLESS STEEL T=0.15MM
 - FINISH:
CONTACT: 50U'' MIN PLATING OVER ALL
GOLD FLASH ON THE CONTACT AREA AND SOLDER AREA
SHELL: SELECTIVE GOLD FLASH IN SOLDER TAIL AREA
50U'' NI MIN. PLATING OVER ALL
 - ALL DIMENSIONS MARKED ▼ MUST BE CONTROLLED BY QC
 - RATED PARAMETERS OF CONNECTOR
4-1. Operating temperature: -40°C to 70°C
4-2. Rated Current: 0.5A
4-3. Rated Voltage: 30V DC Per Contact
 - ELECTRICAL MECHANICAL ENVIRONMENTAL
5-1. Dielectric withstanding Voltage : 500V AC 1min.
5-2. Insulation Resistance: 1000 MΩ Min.
5-3. Normal Force: 100g Min. Per Pin
5-4. Durability: 1000 cycles
5-5. Heat Resistance: 20mΩ MAX.

SIM CARD PIN NO.	PIN NO.
SIM CARD P1	VCC
SIM CARD P2	RST
SIM CARD P3	CLK
SIM CARD P4	RESERVED
SIM CARD P5	GND
SIM CARD P6	VPP
SIM CARD P7	I/O
SIM CARD P8	RESERVED

D	E1506223A	弹高设变	06/06'2015	UNITS: mm	GENERAL TOLERANCE		DRAW:	PART NO: S34-OB08F15A
C	E1504160A	弹高设变	04/01'2015	DATE: 09/09'2014	X. ±0.25	X.° ±5.00°	CHECKED:	TITLE: MICRO SIM CARD成品H=1.50mm
B	E1501044A	外观变更	01/13'2015	SCALE: 8 / 1	.X ±0.15	.X° ±3.00°	APPROVE:	DRAWING NO:
A		NEW	09/09'2014	SHEET: 1 / 1	.XX ±0.10	.XX° ±1.00°	MATERIAL:	
REV.	ECN NO.	DESCRIPTION	DATE	REV. D	FINISH: SEE NOTE		昆山捷皇电子精密科技有限公司 HONGRIDA ELECTRONIC TECHNOLOGY CO.,LTD.	